

BAT24-02LS

Single silicon RF Schottky diode









Product description

This Infineon RF Schottky diode is a silicon low barrier N-type device with an integrated guard ring on-chip for over-voltage protection. Its low barrier height, small forward voltage and low junction capacitance make BAT24-02LS a suitable choice for mixer and detector functions in applications which frequencies are as high as 24 GHz.



Feature list

- Low inductance $L_S = 0.2 \text{ nH (typical)}$
- Low capacitance C = 0.2 pF (typical) at voltage $V_R = 0$ V and frequency f = 1 MHz
- TSSLP-2-1 package (0.62 mm x 0.32 mm x 0.31 mm) with a 0201 foot print
- · Pb-free, RoHS compliant and halogen free

Product validation

Qualified for industrial applications according to the relevant tests of JEDEC47/20/22.

Potential applications

For mixers and detectors in:

Radar systems and modules

Device information

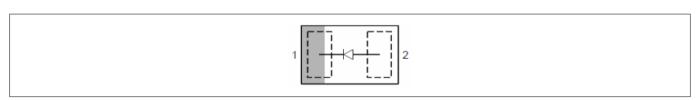


Table 1 Part information

Product name / Ordering code	Package	Pin configuration	Marking	Pieces / Reel
BAT24-02LS / BAT2402LSE6327XTSA1	TSSLP-2-1	Single, leadless	S	15 k

Attention: ESD (Electrostatic discharge) sensitive device, observe handling precautions!

BAT24-02LS Single silicon RF Schottky diode

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Table of contents

Table of contents

	Product description	1
	Feature list	1
	Product validation	1
	Potential applications	1
	Device information	1
	Table of contents	2
1	Absolute maximum ratings	2
2	Electrical performance in test fixture	3
2.1	Electrical characteristics	3
2.2	Characteristic curves	3
3	Package information TSSLP-2-1	7
4	Thermal characteristics	8
5	References	10
	Revision history	10
	Disclaimer	11

1 Absolute maximum ratings

Table 2 Absolute maximum ratings at T_A= 25°C, unless otherwise specified

Parameter	Symbol	Values		Unit	Note or test condition
		Min.	Max.		
Diode reverse voltage	V_{R}	_	4	V	
Forward current	I _F	_	110	mA	
Total power dissipation	P_{TOT}	_	100	mW	T _S ≤ 82°C ¹⁾
Junction temperature	T _J	_	150	°C	
Operating temperature	T_{OP}	_	150		
Storage temperature	T_{STG}	_	150		

Attention: Stresses above the maximum values listed here may cause permanent damage to the device.

Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Exceeding only one of these values may cause irreversible damage to the component.

 $T_{\rm S}$ is the soldering point temperature.

Single silicon RF Schottky diode



Electrical performance in test fixture

Electrical performance in test fixture 2

Electrical characteristics 2.1

Table 3 Electrical characteristics at $T_A = 25$ °C, unless otherwise specified

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Тур.	Max.		
Breakdown voltage	V_{BR}	4	_	_	٧	/ _R = 10 μA
Reverse current	I_{R}	_	_	5	μΑ	V _R = 1 V
Forward voltage	V_{R}	0.16	0.25	0.32	٧	/ _F = 1 mA
		0.25	0.35	0.41		/ _F = 10 mA
Differential forward resistance	R _F	_	8	10	Ω	$I_{\rm F} = 10 \text{mA} / 50 \text{mA}^{1}$
Capacitance	С	_	0.2	0.23	pF	$V_{R} = 0 \text{ V}, f = 1 \text{ MHz}$
Inductance	Ls	0.15	0.2	0.25	nH	2)

2.2 **Characteristic curves**

At T_A = 25 °C, unless otherwise specified

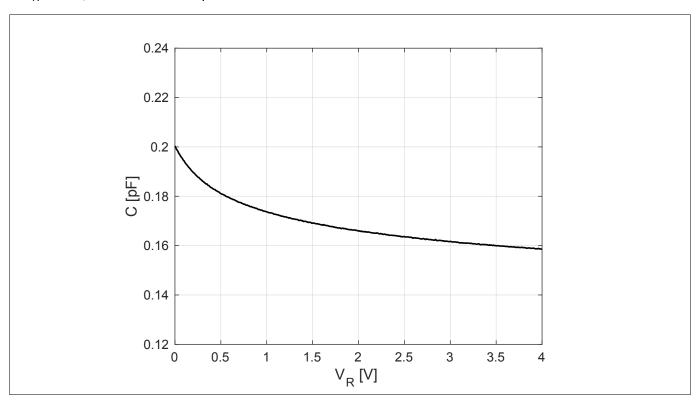


Figure 1 Capacitance C vs. reverse voltage V_R at frequency f = 1 MHz

¹

Parameter is not subject to production test, min/max values are specified by design.

Electrical performance in test fixture

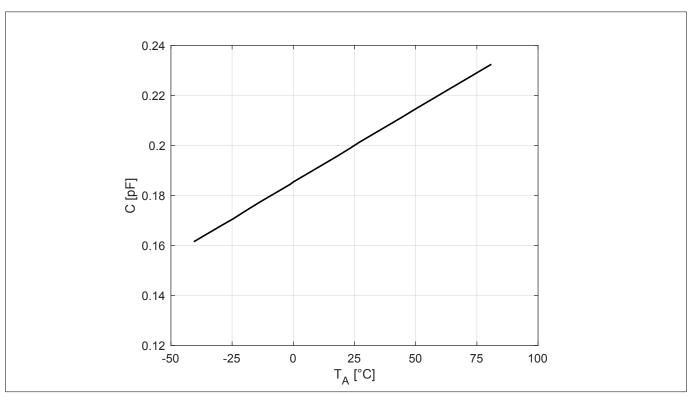


Figure 2 Capacitance C vs. ambient temperature T_A at frequency f = 1 MHz and reverse voltage $V_R = 0$ V

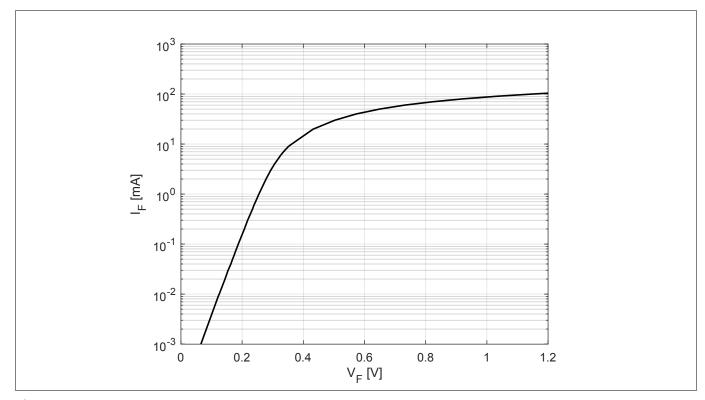


Figure 3 Forward current I_F vs. forward voltage V_F

Electrical performance in test fixture

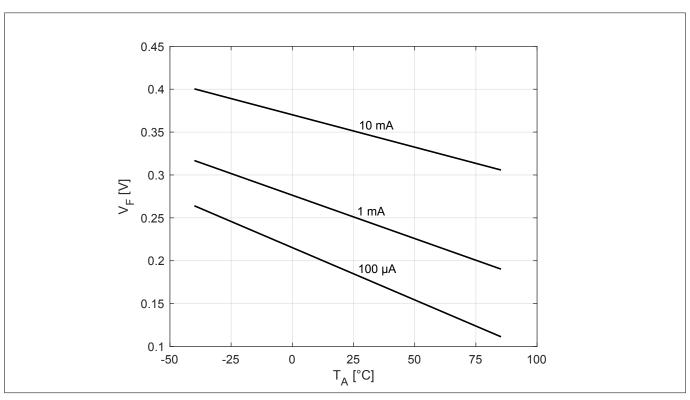


Figure 4 Forward voltage V_F vs. ambient temperature T_A at different forward currents

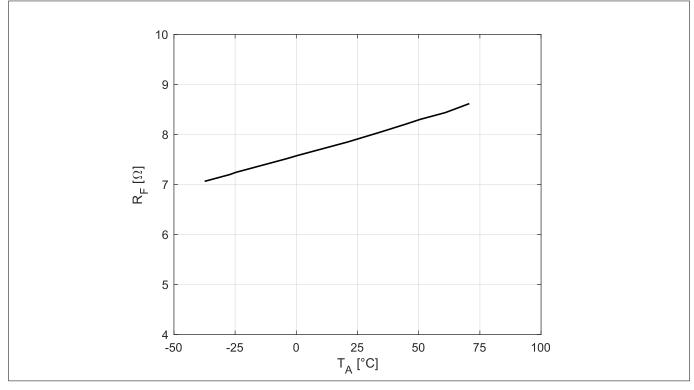


Figure 5 Differential forward resistance R_F vs. ambient temperature T_A between forward currents $I_F = 10$ mA and 50 mA

Electrical performance in test fixture

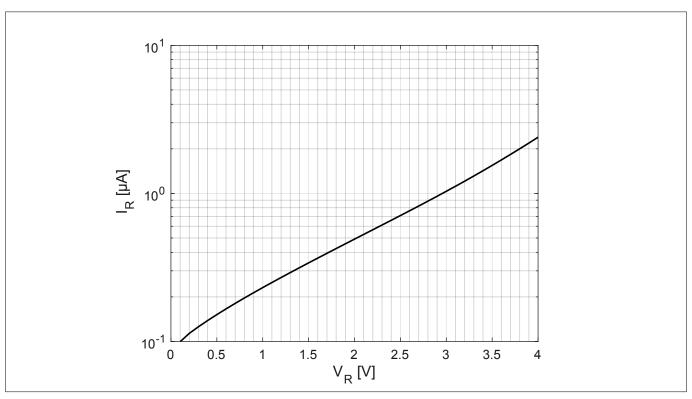


Figure 6 Reverse current I_R vs. reverse voltage V_R

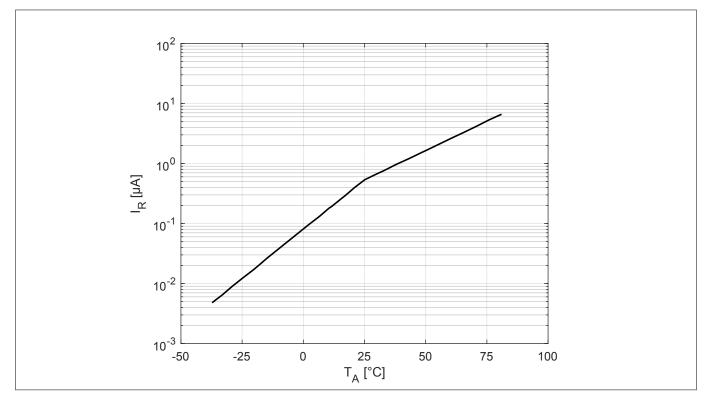


Figure 7 Reverse current I_R vs. ambient temperature T_A at reverse voltage $V_R = 1 \text{ V}$

Note: The curves shown in this chapter have been generated using typical devices but shall not be understood as a guarantee that all devices have identical characteristic curves.

Package information TSSLP-2-1

3 Package information TSSLP-2-1

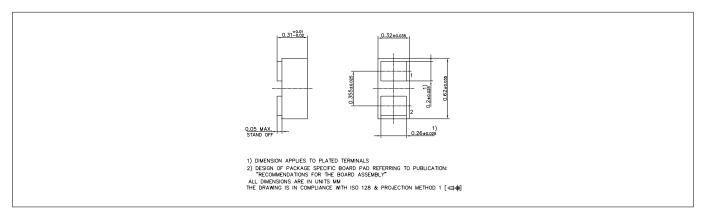


Figure 8 Package outline

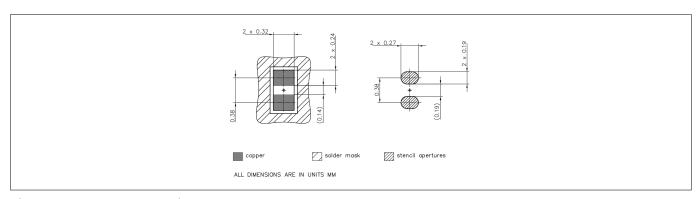


Figure 9 Foot print

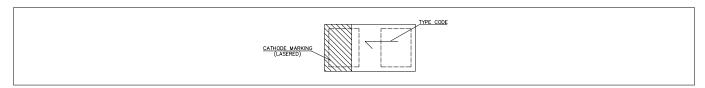


Figure 10 Marking layout example

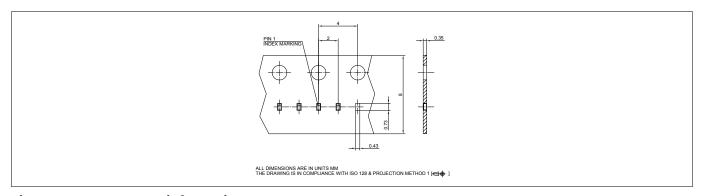


Figure 11 Tape information

Note: See our Recommendations for Printed Circuit Board Assembly of TSLP/TSSLP/TSNP Packages.

The marking layout is an example. For the real marking code refer to the device information on the first page. The number of characters shown in the layout example is not necessarily the real one. The marking layout can consist of less characters.

Single silicon RF Schottky diode



Thermal characteristics

Thermal characteristics 4

Table 4 Thermal resistance

Parameter		Values			Unit	Note or test condition
	bol	Min.	Тур.	Max.		
Thermal resistance	R_{thJS}	_	675	_	K/W	T _S = 82 °C 1)
(junction - soldering point)						

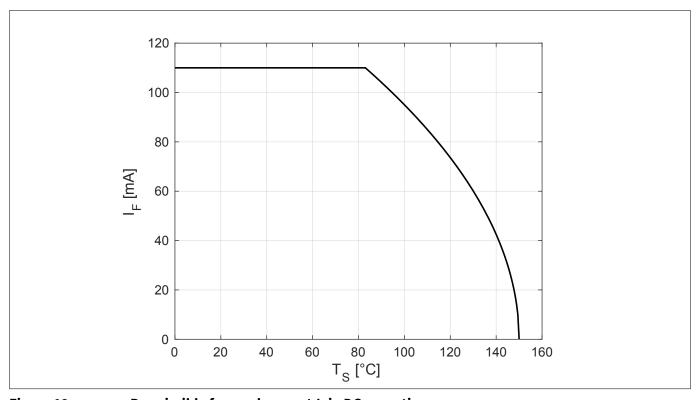


Figure 12 Permissible forward current I_F in DC operation

For R_{thJS} in other conditions refer to the curves in this chapter. 1

Thermal characteristics

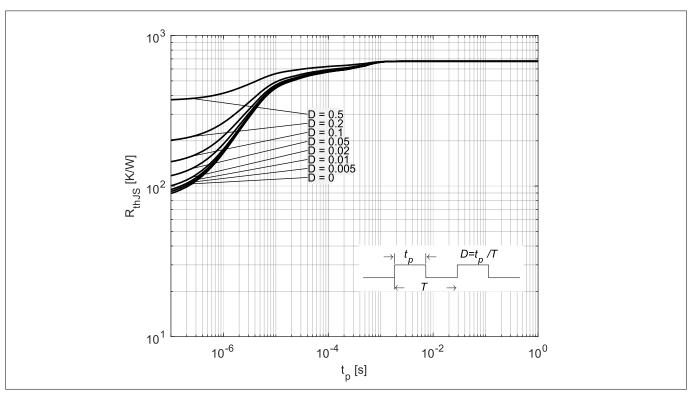


Figure 13 Thermal resistance R_{thJS} in pulse operation

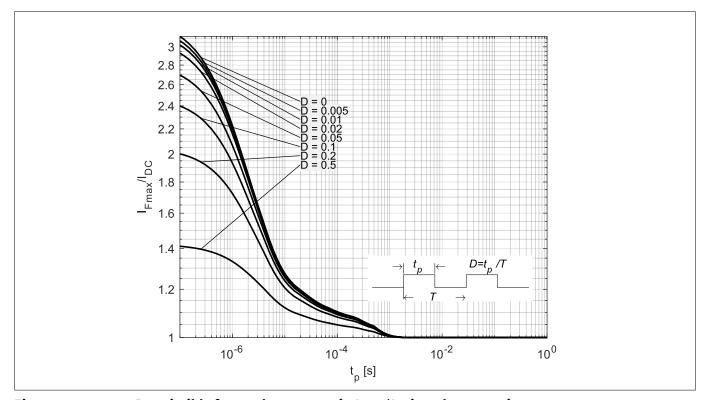


Figure 14 Permissible forward current ratio I_{Fmax}/I_{DC} in pulse operation

BAT24-02LS

Single silicon RF Schottky diode



References

5 References

[1] Infineon AG - Recommendations for Printed Circuit Board Assembly of Infineon TSLP/TSSLP/TSNP Packages

Revision history

Document version	Date of release	Description of changes				
2.0	2018-09-07	 New layout of datasheet Typical values and curves updated to the values of the production (No product or process change behind) 				

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